

L Number	Hits	Search Text	DB	Time stamp
1	8	wafer and (undoped with silicon) same etch\$ and 29/\$.ccls.	USPAT	2002/06/08 11:20
-	179	chang-rick-kiltae.xa.	USPAT	2002/06/07 12:16
-	38	("3275736"   "3670409"   "3818415"   "3823467"   "3937386"   "3998377"   "4067104"   "4189825"   "4655519"   "4695870"   "4716049"   "4846704"   "4893172"   "4902606"   "4924353"   "4950173"   "4950623"   "4955523"   "4975079"   "5006792"   "5067007"   "5086337"   "5130768"   "5152695"   "5173055"   "5181859"   "5196726"   "5199879"   "5214308"   "5228861"   "5311402"   "5349495"   "5354205"   "5360347"   "5380210"   "5455390"   "5632631"   "5802699").PN.	USPAT	2002/06/06 12:00
-	43	("3256589"   "3275736"   "3670409"   "3818415"   "3823467"   "3937386"   "3998377"   "4067104"   "4189825"   "4205889"   "4655519"   "4695870"   "4716049"   "4846704"   "4893172"   "4902606"   "4924353"   "4950173"   "4950623"   "4955523"   "4975079"   "5006792"   "5067007"   "5086337"   "5130768"   "5152695"   "5173055"   "5181859"   "5196726"   "5199879"   "5214308"   "5224264"   "5228861"   "5311402"   "5349495"   "5354205"   "5360347"   "5380210"   "5455390"   "5481798"   "5525545"   "5632631"   "5722159").PN.	USPAT	2002/06/06 12:07
-	1	5802699.pn. and etch\$	USPAT	2002/06/07 06:15
-	1	29/825.ccls. and demarcat\$	USPAT	2002/06/07 06:16
-	1	29/846.ccls. and demarcat\$	USPAT	2002/06/07 06:17
-	173	29/846.ccls. and carrier	USPAT	2002/06/07 06:29
-	3	439/\$.ccls. and wafer and (undoped same silicon)	USPAT	2002/06/07 06:38
-	339	439/82.ccls.	USPAT	2002/06/07 07:29
-	24	439/82.ccls. and etch\$	USPAT	2002/06/07 07:42
-	0	"09693484"	US-PGPUB	2002/06/07 07:42
-	71	29/846.ccls.	US-PGPUB	2002/06/07 07:47
-	36	439/66.ccls.	US-PGPUB	2002/06/07 07:47
-	631	439/66.ccls.	USPAT	2002/06/07 10:56
-	20	439/66.ccls. and suspens\$	USPAT	2002/06/07 07:57
-	11	439/70,71,72.ccls. and suspens\$	USPAT	2002/06/07 07:58
-	0	439/66.ccls. and wafer and (undoped same silicon)	USPAT	2002/06/07 10:56
-	0	439/66.ccls. and (undoped same silicon)	USPAT	2002/06/07 12:56
-	118	439/66.ccls. and silicon	USPAT	2002/06/07 12:12
-	82	29/848.ccls. and mold\$	USPAT	2002/06/07 12:18
-	179	chang-rick-kiltae.xa.	USPAT	2002/06/07 12:16
-	44	29/848.ccls. and mold\$ and cur\$	USPAT	2002/06/07 12:56
-	4047	undoped with silicon	USPAT	2002/06/07 12:58
-	2	(undoped with silicon) same etch\$ and 439/\$.ccls.	USPAT	2002/06/07 13:01
-	10	(undoped with silicon) same etch\$ and 29/\$.ccls.	USPAT	2002/06/08 11:20